



Vishay Siliconix

P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}$ (Ω)	I _D (A)	Q _g (Typ.)		
- 20	0.035 at $V_{GS} = -4.5 \text{ V}$	- 9 ^a			
	$0.049 \text{ at V}_{GS} = -2.5 \text{ V}$	- 9 ^a	13 nC		
	0.072 at V _{GS} = - 1.8 V	- 9 ^a	13110		
	0.130 at V _{GS} = - 1.5 V	- 2			

1.60 mm

PowerPAK SC-75-6L-Single

1.60 mm

FEATURES

Halogen-free According to IEC 61249-2-21 **Definition**



HALOGEN

FREE

TrenchFET® Power MOSFET

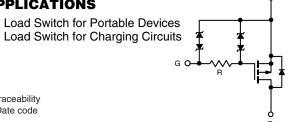
New Thermally Enhanced PowerPAK® SC-75 Package

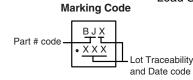
- Small Footprint Area - Low On-Resistance

- 100 % R_g Tested Typical ESD Performance: 2500 V
- Built in ESD Protection with Zener Diode
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

Load Switch for Portable Devices





Ordering Information: SiB457EDK-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unle	ss otherwise r	noted		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V_{DS}	- 20	V	
Gate-Source Voltage		V _{GS} ± 8		¬	
	T _C = 25 °C		- 9 ^a		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	I _D	- 9 ^a		
Continuous Diain Current (1) = 150 C)	T _A = 25 °C		- 6.8 ^{b, c}		
	T _A = 70 °C		- 5.5 ^{b, c}	Α	
Pulsed Drain Current		I _{DM}	- 25	1	
Continuous Source-Drain Diode Current	T _C = 25 °C	I.	- 9 ^a	1	
Continuous Source-Diam Diode Current	T _A = 25 °C	l _S	- 2 ^{b, c}	1	
	T _C = 25 °C		13	W	
Maximum Power Dissipation	T _C = 70 °C	ь	8.4		
Maximum Fower Dissipation	T _A = 25 °C	– P _D	2.4 ^{b, c}		
	T _A = 70 °C		1.6 ^{b, c}	1	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) ^{d, e}			260	1	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	41	51	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	7.5	9.5]	

Notes:

- a. Package limited.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. See Solder Profile (www.vishay.com/ppg?73257). The PowerPAK SC-75 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 105 °C/W.

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SPECIFICATIONS T _J = 25 °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static								
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 20			V		
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	$\Delta V_{DS}/T_J$ $I_D = -250 \mu A$		- 12		mV/°C		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			2.5		IIIV/°C		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu\text{A}$	- 0.4		- 1	V		
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 5	μΑ		
Gale-Source Leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$			± 0.5			
Zara Cata Valtaga Drain Current	1	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$			- 1			
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			- 10			
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 15			Α		
		$V_{GS} = -4.5 \text{ V}, I_D = -4.8 \text{ A}$		0.029	0.035			
	_	V _{GS} = - 2.5 V, I _D = - 4.0 A		0.040	0.049	Ω		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 1.8 V, I _D = - 3.3 A		0.060	0.072			
		V _{GS} = - 1.5 V, I _D = - 1.5 A		0.085	0.130			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 4.8 A		16		S		
Dynamic ^b	l				l			
Total Gate Charge	0	$V_{DS} = -10 \text{ V}, V_{GS} = -8 \text{ V}, I_{D} = -6.8 \text{ A}$		22	44			
Oata Causa Chausa	Q_g			13	26	nC		
Gate-Source Charge	Q_{gs}	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -6.8 \text{ A}$	4	1.2				
Gate-Drain Charge	Q _{gd}			3				
Gate Resistance	R_g	f = 1 MHz	0.28	1.4	2.8	kΩ		
Turn-On Delay Time	t _{d(on)}			0.34	0.51			
Rise Time	t _r	V_{DD} = - 10 V, R_L = 1.8 Ω		0.90	1.35			
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 5.5 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		3.00	4.50			
Fall Time	t _f			1.90	2.90	us		
Turn-On Delay Time	t _{d(on)}			0.17	0.26			
Rise Time	t _r	V_{DD} = - 10 V, R_L = 1.8 Ω		0.45	0.70			
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -5.5 \text{ A}, V_{GEN} = -8 \text{ V}, R_g = 1 \Omega$		5.5	8.30			
Fall Time	t _f			2.00	3.50			
Drain-Source Body Diode Characterist	cs							
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 9	Α.		
Pulse Diode Forward Current	I _{SM}				- 25	- A		
Body Diode Voltage	V _{SD}	I _S = - 5.5 A, V _{GS} = 0 V		- 0.85	- 1.2	V		

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

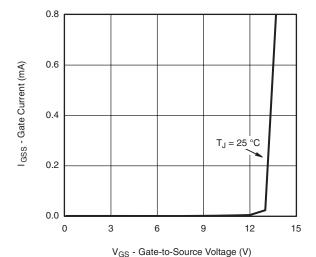
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

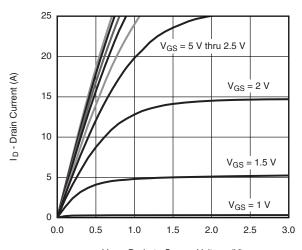


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

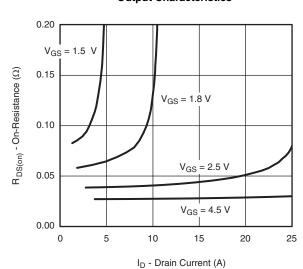


Gate Current vs. Gate-Source Voltage

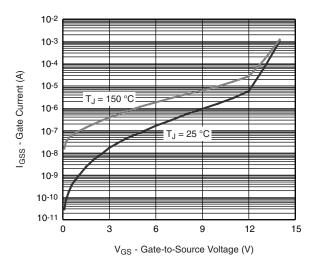


V_{DS} - Drain-to-Source Voltage (V)

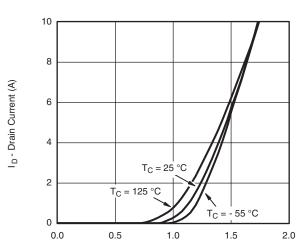
Output Characteristics



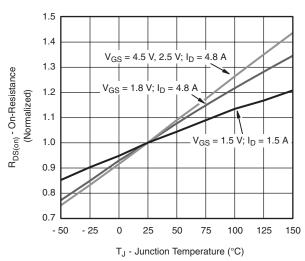
On-Resistance vs. Drain Current



Gate Current vs. Gate-Source Voltage



V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics**

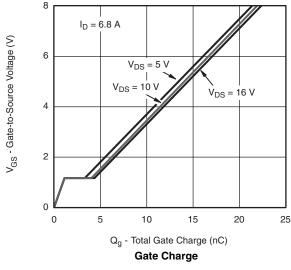


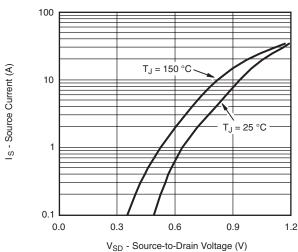
On-Resistance vs. Junction Temperature

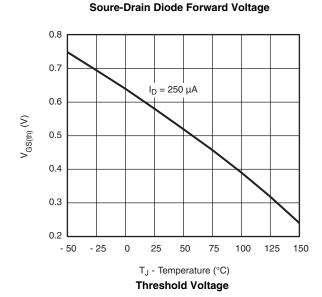
Vishay Siliconix

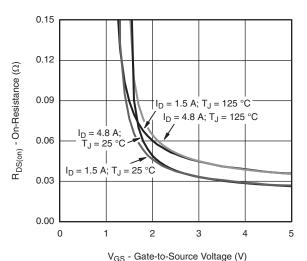
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

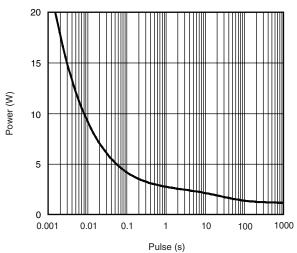




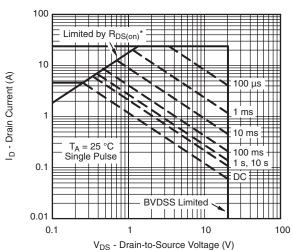




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



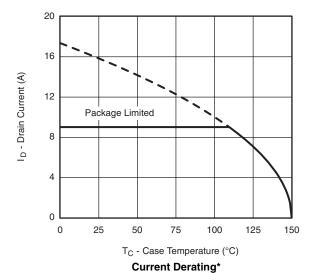
* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

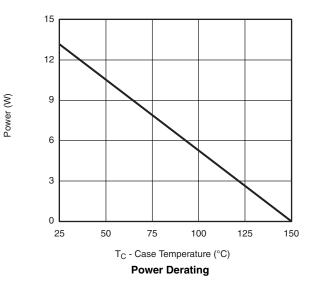
Safe Operating Area, Junction-to-Ambient



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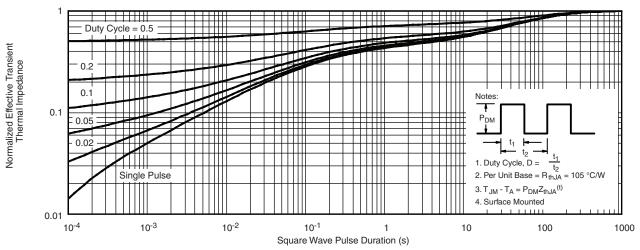
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^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

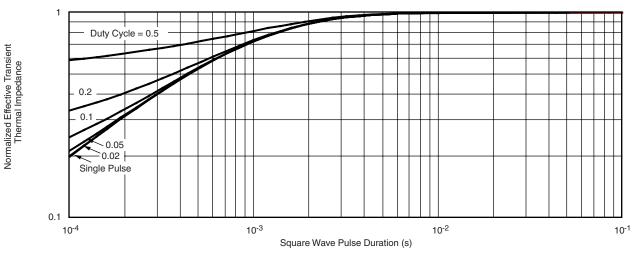
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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